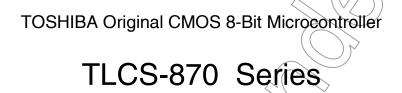
TOSHIBA



TMP87PP23FG



Semiconductor Company

Document Change Notification

The purpose of this notification is to inform customers about the launch of the Pb free version of the device. The introduction of a Pb-free replacement affects the datasheet. Please understand that this notification is intended as a temporary substitute for a revision of the datasheet.

Changes to the datasheet may include the following, though not all of them may apply to this particular device.

1. Part number

Example: TMPxxxxxxFG TMPxxxxxxFG

All references to the previous part number were left unchanged in body text. The new part number is indicated on the prelims pages (cover page and this notification).

2. Package code and package dimensions

Example: LQFP100-P-1414-0.50C

LQFP100-P-1414-0.50F

All references to the previous package code and package dimensions were left unchanged in body text. The new ones are indicated on the prelims pages.

3. Addition of notes on lead solderability

Now that the device is Pb-free, notes on lead solderability have been added.

Ι

4. RESTRICTIONS ON PRODUCT USE

The previous (obsolete) provision might be left unchanged on page 1 of body text. A new replacement is included on the next page.

5. Publication date of the datasheet

The publication date at the lower right corner of the prelims pages applies to the new device.

1. Part number

2. Package code and dimensions

Previous Part Number (in Body Text)	Previous Package Code (in Body Text)	New Part Number	New Package Code	ОТР
TMP87PP23F	P-QFP100-1420-0.65A	TMP87PP23FG	QFP100-P-1420-0.65Q	_

^{*:} For the dimensions of the new package, see the attached Package Dimensions diagram.

3. Addition of notes on lead solderability

The following solderability test is conducted on the new device

Lead solderability of Pb-free devices (with the G suffix)

Test	Test Conditions	Remark
Solderability	(1) Use of Lead (Pb)	Leads with over 95% solder coverage till lead forming are acceptable.

4. RESTRICTIONS ON PRODUCT USE

The following replaces the "RESTRICTIONS ON PRODUCT USE" on page 1 of body text.

RESTRICTIONS ON PRODUCT USE

20070701-EN

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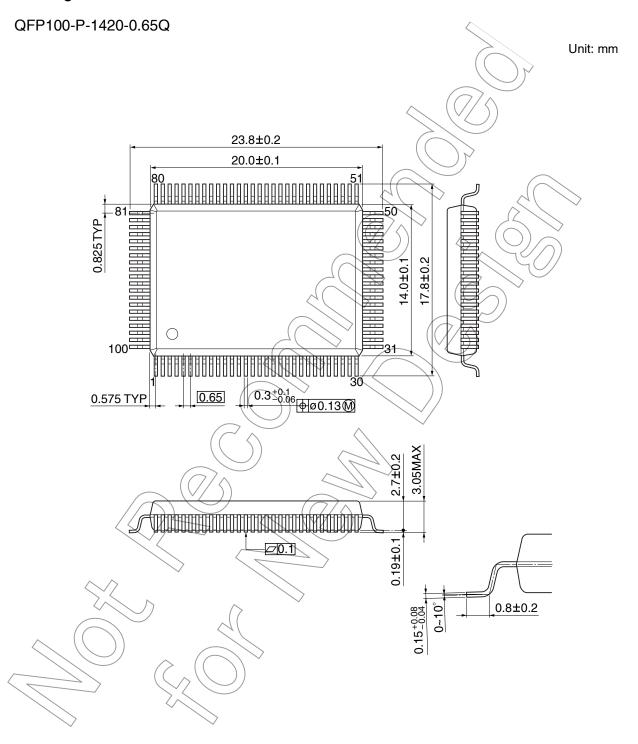
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 as a result of noncompliance with applicable laws and regulations.
- For a discussion of how the reliability of microcontrollers can be predicted, please refer to Section 1.3 of the chapter entitled Quality and Reliability Assurance/Handling Precautions.

5. Publication date of the datasheet

The publication date of this datasheet is printed at the lower right corner of this notification.

(Annex)

Package Dimensions

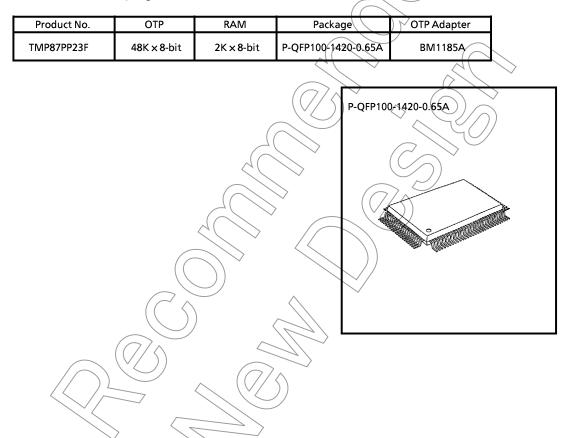


III 2008-03-06

CMOS 8-Bit Microcontroller

TMP87PP23F

The TMP87PP23 is a One-Time PROM microcontroller with low-power 384K bits electrically programmable read only memory for the TMP87CM23A/CP23 system evaluation. The TMP87PP23 is pin compatible with the TMP87CM23A/CP23. The operations possible with the TMP87CM23A/CP23 can be performed by writing programs to PROM. The TMP87PP23 can write and verify in the same way as the $\sqrt{1/25}/1000D$ using an adapter socket BM1185A and an EPROM programmer.



For a discussion of how the reliability of microcontrollers can be predicted, please refer to Section 1.3 of the chapter entitled Quality and Reliability Assurance / Handling Precautions.

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2001-10-03 3-23-111

OPERATIONAL DESCRIPTION

The following explains the TMP87PP23 hardware configuration and operation. The configuration and functions of the TMP87PP23 are the same as those of the TMP87CM23A/CP23 except in that a one-time PROM is used instead of an on-chip mask ROM.

The TMP87PP23 is placed in the *single-clock* mode during reset. To use the dual-clock mode, the low-frequency oscillator should be turned on by executing [SET (SYSCR2). XTEN] instruction at the beginning of the program.

1. OPERATING MODE

The TMP87PP23 has two modes: MCU and PROM.

1.1 MCU mode

The MCU mode is activated by fixing the TEST / VPP pin at low level.

In the MCU mode, operation is the same as with the TMP87CM23A/CP23 (the TEST / VPP pin cannot be used open because it has no built-in pull-down resistance).

1.1.1 Program Memory

The TMP87PP23 has a $48K \times 8$ -bit (addresses 4000_H -FFFF_H in the MCU mode, addresses) 14000_H -1FFFF_H in the PROM mode) of program memory (OTP).

When the TMP87PP23 is used as a system evaluation of the TMP87CM23A/P23, the data is written to the program storage area shown in figure 1-1.

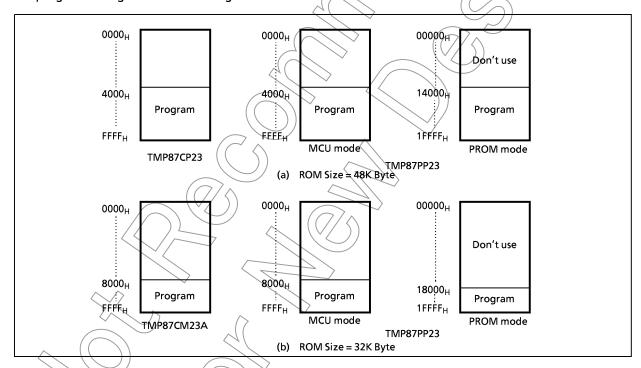


Figure 1-1. Program Memory Area

Note: Either write the data FF_H to the unused area or set the PROM programmer to access only the program storage area.

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1.1.2 Data Memory

The TMP87PP23 has an on-chip 2K × 8-bit data memory (static RAM).

1.1.3 Input/Output Circuitry

(1) Control pins

The control pins of the TMP87PP23 are the same as those of the TMP87CM23A/CP23 except that the TEST pin has no built-in pull-down resistance.

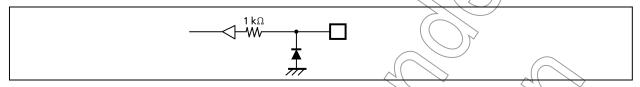


Figure 1-2. TEST Pin

(2) I/O ports

The I/O circuitries of TMP87PP23 I/O ports are the same as the those of TMP87CM23A/CP23.



1.2 PROM mode

The PROM mode is activated by setting the TEST, RESET pin and the ports P17 to P10, P22 to P20 and P61 as shown in Figure 1-3 The PROM mode is used to write and verify programs with a general-purpose PROM programmer.

Note: The high-speed programming mode can be used for program operation.

The TMP87PP23 is not supported an electric signature mode, so the ROM type must be set to TC571000D.

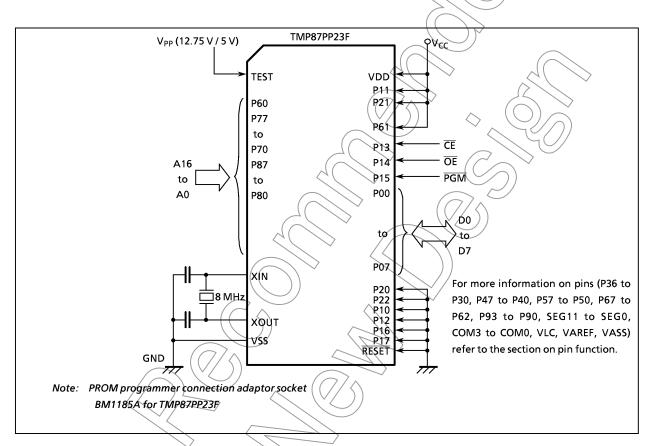


Figure 1-3. Setting for PROM Mode

1.2.1 Programming Flowchart (High-speed Programming Mode)

The high-speed programming mode is achieved by applying the program voltage (+ 12.75 V) to the VPP pin when Vcc = 6.25 V. After the address and input data are stable, the data is programmed by applying a single 0.1 ms program pulse to the \overline{PGM} input. The programmed data is verified. If incorrect, another 0.1 ms program pulse is applied. This process should be repeated (up to 25 times) until the program operates correctly. After that, change the address and input data, and program as before. When programming has been completed, the data in all addresses should be verified with Vcc = Vpp = 5 V.

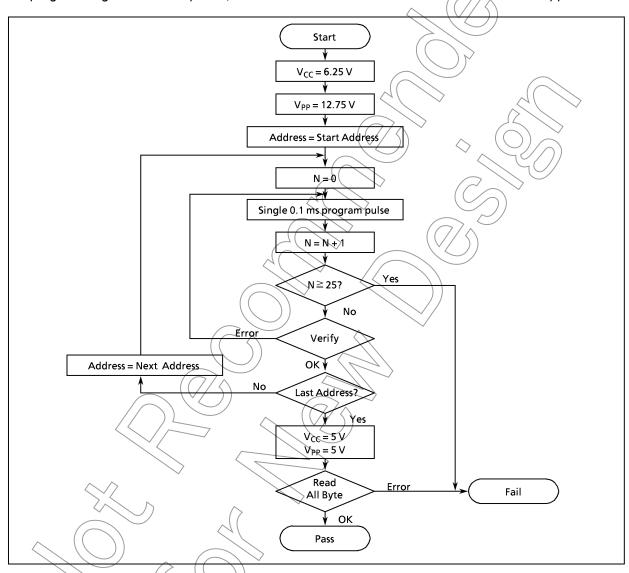


Figure 1-4. Flow Chart of High-speed Programming

1.2.2 Writing method for general-purpose PROM program

(1) Adapters

BM1185A: TMP87PP23F

(2) Adapter setting Switch (SW1) is set to side N.

(3) PROM programmer specifying

i) PROM type is specified to TC571000D.

Writing voltage: 12.75 V (high-speed program mode)

ii) Data transfer (copy) (Note 1)

In the TMP87PP23, EPROM is within the addresses 14000_H to 1FFFF_H. Data is required to be transferred (copied) to the addresses where it is possible to write. The program area in MCU mode and PROM mode is referred to "Program memory area" in figure 1-1.

Ex. In the block transfer (copy) mode, executed as below.

ROM capacity of 48KB: transferred addresses 04000_H to 0FFFF_H to addresses 14000 to 1FFFF_H

iii) Writing address is specified. (Note 1)

Start address: 14000_H End address: 1FFFF_H

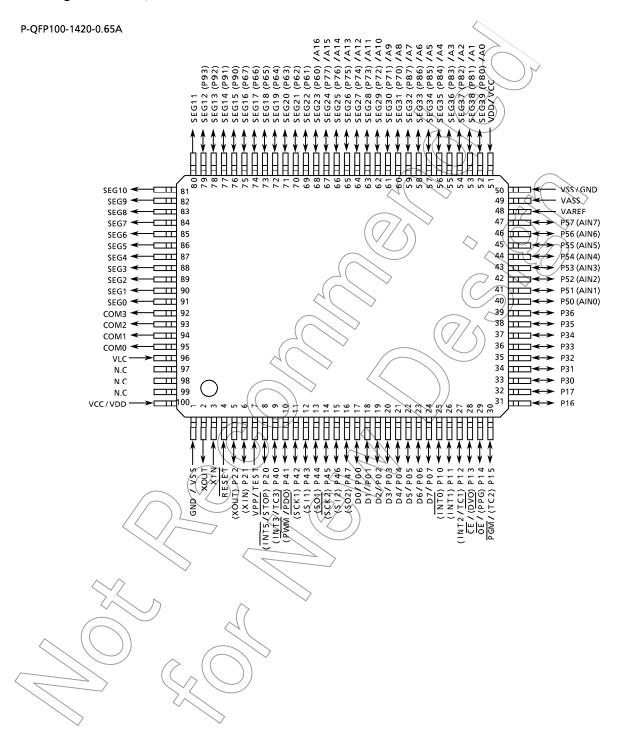
(4) Writing

Writing/Verifying is required to be executed in accordance with PROM programmer operating procedure.

- Note 1: The specifying method is referred to the **PROM** programmer description. Either write the data FF_H to the unused area or set the **PROM** programmer to access only the program storage area.
- Note 2: When MCU is set to an adapter or the adapter is set to PROM programmer, a position of pin 1 must be adjusted. If the setting is reversed, MCU, the adapter and PROM program is damaged.
- Note 3: The TMP87PR23 does not support the electric signature mode (hereinafter referred to as "signature"). If the signature is used in PROM program, a device is damaged due to applying $\pm 0.5V$ to the address pin 9 (A9). The signature must not be used.



Pin Assignments (Top View)



Pin Function

The TMP87PP23 has two modes: MCU and PROM.

(1) MCU mode

In this mode, the TMP87PP23 is pin compatible with the TMP87CM23A/CP23 (fix the TEST pin at low level.)

(2) PROM mode

Input / Output	Function	Pin Name (MCU mode)
		P60
Input	PROM address inputs	P77 to P70
		P87 to P80
1/0	PROM data input/outputs	P07 to P00
	Chip enable signal input (active low)	P13
Input	Output enable signal input (active low)	P14
	Program mode signal input (active low)	P15
	+ 12.75 V (5 V (Program supply voltage)	TEST
Power supply	+6.25 (/5)	VDD
	ov	vss
	Pull-up with resistance for input processing.	
$\sim (0/5)$		
	~ (7/\)	
40		
	PROM mode setting pin. Be fixed at high level.	
~		
\mathcal{I}	DROM made setting pin. Be fixed at level and	
4	PROM mode setting pm. Be fixed at low level.	
Input	Connect on SMILIT posillator to stabilize the internal sta	
Output	Connect an own 2 oscillator to stabilize the internal sta	ite.
Power and a	OV (CND)	
rower supply	ov(GND)	
Output		
Output	Open	
Power supply		
	Input Power supply Input Output Power supply Output	Input PROM data input/outputs Chip enable signal input (active low) Output enable signal input (active low) Program mode signal input (active low) + 12.75 V (5 V Program supply voltage) + 6.25 V /5 V OV PROM mode setting pin. Be fixed at high level. PROM mode setting pin. Be fixed at low level. Input Connect an 8MHz oscillator to stabilize the internal state of the power supply Output Output Open

Electrical Characteristics

Absolute Maximum Ratings (V_{SS} = 0 V)

Parameter	Symbol	Pin	Ratings	Unit
Supply Voltage	V_{DD}		- 0.3 to 6.5	٧
Program Voltage	V_{PP}	TEST/V _{PP}	-0.3 to 13.0	٧
Input Voltage	V_{IN}		$0.3 \text{ to V}_{DD} + 0.3$	٧
Output Voltage	V _{OUT}		– 0.3 to V _{DD} + 0.3	٧
Output Current (Per 1 pin)	I _{OUT1}	Ports P0, P1, P2, P3, P5, P6, P7, P8, P9, P4 (except P41)	3.2	mA
output current (i er i pin)	I _{OUT2}	P41	30	
Output Current (Total)	Σ l _{OUT1}	Ports P0, P1, P2, P3, P5, P6, P7, R8, P9, P4 (except P41)	120	mA
	ΣI_{OUT2}	P41	30	
Power Dissipation [Topr = 70°C]	PD		350	mW
Soldering Temperature (time)	Tsld		260 (10 s)	°C
Storage Temperature	Tstg		- 55 to 125	°C
Operating Temperature	Topr	4()	– 30 to 70	°C

Note1: The absolute maximum ratings are rated values which must not be exceeded during operation, even for an instant. Any one of the ratings must not be exceeded. If any absolute maximum rating is exceeded, a device may break down or its performance may be degraded, causing it to catch fire or explode resulting in injury to the user. Thus, when designing products which include this device, ensure that no absolute maximum rating value will ever be exceeded.

Note 2: The absolute maximum input/output voltage ratings for the TMP87CM23AICP23 are -0.3 to VDD + 0.3 [V] at all

I/O ports including sink open drain output ports. (However, the VPP pin of TMP87PP23 is not contained in these condition.)

Recommended Operating Conditions

 $(V_{SS} = 0V, Topr = -30 to 70^{\circ}C)$

Parameter	Symbol	(Pin)	~	Condition	Min	Max	Unit
Supply Voltage 📿	((7/4)	fc = 8 IVIHz	NORMAL1, 2 mode	4.5		
			f (2/2/1/2)	NORMAL1, 2 mode			
	(V _{DD})		fc = 4.2 MHz	IDLE1, 2 mode	2.7	5.5	٧
	\\\) S	SLOW mode	2.7		
			32.768 kHz	SLEEP mode			
\wedge		· \		STOP mode	2.0		
	VIHI	Except hysteresis input	V _{DD} ≧ 4.5 V		$V_{DD} \times 0.70$		
Input High Voltage	V _{IH2}	Hysteresis input	V	DD = 4.3 V	$V_{DD} \times 0.75$	V_{DD}	V
	V _{IH3}	(1)	V	_{DD} <4.5 V	$V_{DD} \times 0.90$		
	V _{IL1}	Except hysteresis input	V	_{DD} ≥ 4.5 V		$V_{DD} \times 0.30$	
Input Low Voltage	V _{IL2} ((Hysteresis input	•	DD = 4.5 V	0	$V_{DD} \times 0.25$	V
	V _{IL3}		V	_{DD} <4.5 V		$V_{DD} \times 0.10$	
	fc	XIN, XOUT	V_{DD}	= 4.5 to 5.5 V	0.4	8.0	v
Clock Frequency		AIN, AQUI	V_{DD}	= 2.7 to 5.5 V	0.4	4.2	
	fs	XTIN, XTOUT			30.0	34.0	kHz

Note 1: The recommended operating conditions for a device are operating conditions under which it can be guaranteed that the device will operate as specified. If the device is used under operating conditions other than the recommended operating conditions (supply voltage, operating temperature range, specified AC/DC values etc.), malfunction may occur. Thus, when designing products which include this device, ensure that the recommended operating conditions for the device are always adhered to.

Note 2: Clock frequency fc: Supply voltage range is specified in NORMAL1/2 mode and IDLE1/2 mode.

DC Characteristics

 $(V_{SS} = 0 \text{ V, Topr} = -30 \text{ to } 70^{\circ}\text{C})$

Parameter	Symbol	Pin	Condition	Min	Тур.	Max	Unit
Hysteresis Voltage	V _{HS}	Hysteresis inputs		(-	0.9	-	٧
	I _{IN1}	TEST					
Input Current	I _{IN2}	Open drain ports and tri-state ports	$V_{DD} = 5.5 \text{ V},$ $V_{IN} = 5.5 \text{ V}/0 \text{ V}$	\mathcal{L}	_	± 2	μΑ
	I _{IN3}	RESET, STOP					
Input Low Current	I _{IL}	Push-pull ports	$V_{DD} = 5.5 \text{ V}, V_{IN} = 0.4 \text{ V}$	_	_	- 2	mA
Input Resistance	R _{IN2}	RESET		100	220	450	$\mathbf{k}\Omega$
Output Leakage Current	I _{LO}	Open drain ports	$V_{DD} = 5.5 \text{ V}, V_{OUT} = 5.5 \text{ V}$	_	$\langle f \rangle$	\d	μΑ
Segment Output Low Resistance	R _{OS1}	SEG39 to SEG0			20	/ //	kΩ
Common Output Low Resistance	R _{OC1}	COM3 to COM0			4		Kaz
Segment Output High Resistance	R _{OS2}	SEG39 to SEG0	V _{DD} =5.V,		200		kΩ
Common Output High Resistance	R _{OC2}	COM3 to COM0	V _{DD} - V _{LC} = 3 V		200		Kaz
	V _{O 2/3}		\triangleright (\vee)	3.8	4.0	4.2	
Segment/Common Output Voltage	V _{O 1/2}	SEG39 to SEG0 and COM3 to COM0		3.3	3.5	3.7	V
	V _{O 1/3}			2.8	3.0	3.2	
	V _{OH1}	Push-pull ports (P4 port)	$V_{DD} = 4.5 \text{ V}, I_{OH} = -200 \mu \text{A}$	2.4	_	-	
Output High Voltage	V _{OH2}	Tri- state ports (P0, P1, P5 ports)	$V_{DD} = 4.5 \text{ V}, \ I_{OH} = -0.7 \text{ mA}$	4.1	-	1	V
Output Low Voltage	V _{OL}	Except XOUT and P41	$V_{DD} = 4.5 \text{ V}, I_{OL} = 1.6 \text{ mA}$	_	_	0.4	٧
Output Low Current	I _{OL3}	P41	$V_{DD} = 4.5 \text{ V}, V_{OL} = 1.0 \text{ V}$	_	20	ı	mA
Supply Current in NORMAL 1 , 2 mode			$V_{DD} = 5.5 V$ fc=8 MHz	_	12	18	A
Supply Current in IDLE 1, 2 mode			fs = 32.768 kHz V _{IN} = 5.3 V / 0.2 V	_	6	10	mA
Supply Current in SLOW mode	DD		V _{DD} = 3.0 V fs = 32.768 kHz	_	30	60	μΑ
Supply Current in SLEEP mode			V _{IN} = 2.8 V / 0.2 V LCD driver is not enable	_	15	30	μΑ
Supply Current in STOP mode	5		V _{DD} = 5.5 V V _{IN} = 5.3 V / 0.2 V		0.5	10	μΑ

Note 1: Typical values show those at Topr=25°C, $V_{DD} = 5 V$.

Note 2: Input Current; The current through pull-up or pull-down resistor is not included.

Note 3: IDD : Except for IREF

Note 4: Output resistors Ros, Roc indicate "on" when switching levels.

Note 5: V_{O2/3} indicates an output voltage at the 2/3 level when operating in the 1/4 or 1/3 duty mode.

Note 6: $V_{01/2}$ indicates an output voltage at the 1/2 level when operating in the 1/2 duty or static mode.

Note 7: $V_{01/3}$ indicates an output voltage at the 1/3 level when operating in the 1/4 or 1/3 duty mode.

Note 8: When using LCD, it is necessary to consider values of Ros1/2 and Rbc1/2.

Note 9: Times for SEG/COM output switching on: Ros1, Roc1: 26/fc, 2/fc (s)

Ros2, Roc2: $1/(n, f_F)$

(1/n: duty, f_F : frame frequency)

AD Conversion Characteristics

 $(V_{SS} = 0V, V_{DD} = 2.7 \text{ to } 5.5V, Topr = -30 \text{ to } 70^{\circ}C)$

ParameteR	Symbol	Condition	Min	Тур.	Max	Unit
	V _{AREF}		2.7	7	V_{DD}	
Analog Reference Voltage	V _{ASS}	$V_{AREF} - V_{ASS} \ge 2.5 V$	Vşs	(1.5	V
Analog Input Voltage	V_{AIN}		V _{ASS}) _	V _{AREF}	V
Analog Supply Current	I _{REF}	$V_{AREF} = 5.5 \text{ V}, \ V_{ASS} = 0.0 \text{ V}$		0.5	1.0	mA
Nonlinearity Error		$V_{DD} = 5.0 \text{ V}, V_{SS} = 0.0 \text{ V}$ $V_{\Delta REF} = 5.000 \text{ V}$		-	±1	
Zero Point Error		V _{ASS} = 0.000 V		_<	±1	>
Full Scale Error		$V_{DD} = 2.7 \text{ V}, V_{SS} = 0.0 \text{ V}$ $V_{AREF} = 2.700 \text{ V}$	_		<u>+</u> 1	LSB
Total Error	·	V _{ASS} = 0.000 V)) - 💠		+ 2	

Note: Quantizing error is not contained in those errors.

AC Characteristics

 $(V_{SS} = 0 \text{ V}, V_{DD} = 4.5 \text{ to } 5.5 \text{ V}, \text{Topr} = +30 \text{ to } 70^{\circ}\text{C}$

Parameter	Symbol	Condition	Min	Тур.	Max	Unit
Machine Guda Time		In NORMAL 1, 2 mode In IDLE 1, 2 mode	0,95	-	10	
Machine Cycle Time	t _{cy}	In SLOW mode In SCEEP mode	117.6	ı	133.3	μ\$
High Level Clock Pulse Width	t _{WCH}	For external clock operation	50	_	_	ns
Low Level Clock Pulse Width	/twci//	(XIN input), fc = 8 MHz				
High Level Clock Pulse Width Low Level Clock Pulse Width	t _{WSH}	For external clock operation (XTIN input), fs=32.768 kHz	14.7	_	_	μS

 $(V_{SS} = 0 \text{ V}, V_{DD} = 2.7 \text{ to } 5.5 \text{ V}, \text{Topr} = -30 \text{ to } 70^{\circ}\text{C})$

Parameter	Symbol	Condition	Min	Тур.	Max	Unit
	<	In NORMAL 1, 2 mode	0.95		10	
Machine Cycle Time	+	In DLE 1, 2 mode	0.95	-	10	
Machinecycle Thile	ccy	In SLOW mode	117.6		133.3	μS
	\bigcirc	In SLEEP mode	117.0	1	155.5	
High Level Clock Pulse Width	twch	For external clock operation	110			ns
Low Level Clock Pulse Width	twcL	(XIN input), fc = 8 MHz	110	ı	ı	115
High Level Clock Pulse Width	t _{WSH}	For external clock operation	14.7			
Low Level Clock Pulse Width	t _{WSL}	(XTIN input), fs = 32.768 kHz	14.7	ı	ı	μS

Recomended Oscillating Condition-1

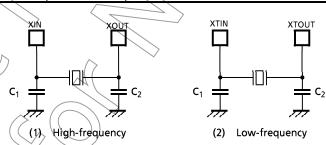
 $(VSS = 0 \text{ V}, \text{ VDD} = 4.5 \text{ to } 5.5 \text{ V}, \text{ Topr} = -30 \text{ to } 70^{\circ}\text{C})$

Parameter	Osillator	Frequency	Recommender COndition
			Oscillator ()) C ₁ C ₂
			KYOCERA KBR8.0M 30pF 30pF
			Standard/Lead Type CSA8.00MTZ Built-in Built-in
			(MURATA) CST8.00MTW 30pF 30pF
	Ceramic Resonator	8 MHz	Standard/SMP Type CSAC8.00MT 30pF 30pF
Himb			Standard/Small ChipType CSTC8:00M7 Built-in Built-in
High-			(MURATA) 30pF 30pF
frequency		4 MHz	KYOCERA KBR4:0MS 30pF 30pF
		8 MHz	TOYOCOM (210B) 8.0000
	Crystal Oscillator	4 MHz	TOYOCOM 204B 4.0000 20pF 20pF
Low-frequency	Crystal Oscillator	32.768 kHz	NDK

Recomended Oscillating Condition-2

 $(VSS \neq 0 V, VDD = 2.7 \text{ to } 5.5 V, Topr = -30 \text{ to } 70^{\circ}C$

Parameter	Osillator	Frequency	Recommer Oscillato	\ \	Recomn Cond	
			Oscillato	or //	C ₁	C ₂
			Standard/Lead Type	CSA4.00MG	30pF	30pF
			(MURATA)	CST4.00MGW	Built-in 30pF	Built-in 30pF
High-	Ceramic Resonator	4 MHz	Standard/SMD Type (MURATA)	CSA4.00MGC CSAC4.00MGCM	30pF	30pF
frequency		(////		CSTC4.00MG	Built-in	Built-in
					30pF	30pF
			Standard/Small/Chin Tyno	CSTCS 4 DONAC	Built-in	Built-in
			Standard/Small Chip Type	C31C34.00IVIG	10pF	10pF



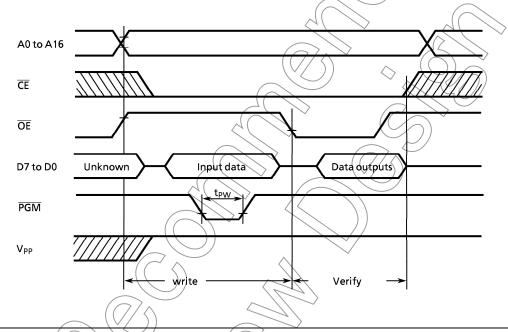
Note 1: When used in high electric field such as a picture tube, the package is recommended to be electrically shielded to maintain a regular operation.

Note 2: The product numbers and specifications of the resonators by Murata Manufacturing Co., Ltd. are subject to change. For up-to-date information, please refer to the following URL; http://www.murata.co.jp/search/index.html

					1)	
Parameter	Symbol	Condition	Min	Тур.	Max	Unit
nput High Voltage	V _{IH4}		V _{CC} × 0.7	((/	V _{CC}	٧
nput Low Voltage	V _{IL4}		0		V _{CC} × 0.12	V
Power Supply Voltage	V _{CC}		4.75	5.0	5.25	V
Program Power Supply Voltage	V _{PP}					
Address Access Time	t _{ACC} V _{CC}	c = 5.0 ± 0.25 V		1.5tcyc + 300	4/- >	ns
A16+0 A0						
A16 to A0	Х		\searrow		▽	
<u>CE</u>					/////	
<u>oe</u>		4()			/////	
PGM ////						
D7 to D0	High-Z	tacc	Data outputs	X//// >		

(2) High-Speed Programming Operation

Parameter	Symbol	Condition	Min	Фур.	Max	Unit
Input High Voltage	V _{IH4}		V _{CC} × 0.7	1	V _{cc}	٧
Input Low Voltage	V _{IL4}		0		y _{CC} × 0.12	٧
Power Supply Voltage	V _{CC}		6.0	6,25	6.5	>
Program Power Supply Voltage	V _{PP}		12.5	12.75	13.0	٧
Initial Program Pulse Width	t _{PW}	V _{CC} = 6.0 V	0.095	0,1	0.105	ms



Note 1: When V_{cc} power supply is turned on or after, V_{pp} must be increased. When V_{cc} power supply is turned off or before, V_{pp} must be increased.

Note 2: The device must not be set to the EPROM programmer or picked op from it under applying the program voltage (12.5 V \pm 0.5 V = V) to the V_{pp} pin as the device is damaged.

Note 3: Be sure to execute the recommended programing mode with the recommended programing adaptor. If a mode or an adaptor except the above, the misoperation sometimes occurs.